

AN7397K, AN7397S

Spatializer IC for I²C bus

Overview

Spatializer Audio Processor is a signal processing technology, monopolized by Desper Products, Inc., that was developed for commercial electronics and multimedia markets, and is based on Desper's "PRO Spatializer" that is a 3-D audio production system for business use. The AN7397K, AN7397S utilizes the innovative technology adopted in that system, and provides sound enhancement effect and sound expansion with the conventional 2-speaker stereo system.

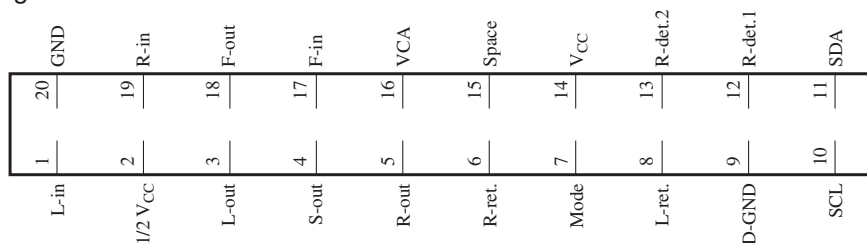
Features

- Provides deep 3-D sound with conventional 2-speaker system.
- The audio signal recorded through this IC can be reproduced with usual stereo system.
- Performs optimal processing to the sound source recorded with surround-effect so as not to give double effects.
- Sound localization can be varied.
- A pseudo stereo effect for the monaural audio signal is achieved.
- Positions and moves each sound source on 270° arc in real time.
- An on-chip serial control bus (i.e., I²C) to vary space-effect and change modes.

Applications

- Televisions, videos, audio equipment, DVDs, personal computers, and game machines

Pin Assignment



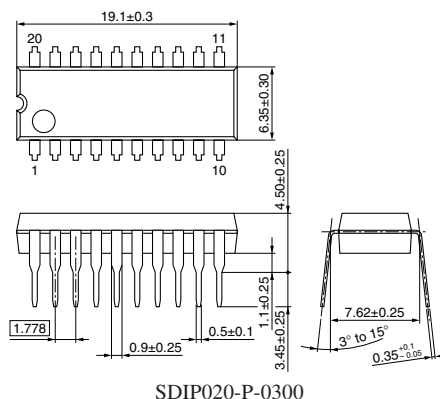
Note) Spatializer[®] and the device trademark of circle-in-square  are owned by Desper Products Inc.

This product can be used with the consent of the Desper Products Inc.

Under the terms of the agreement between Matsushita Electric and Desper Products Inc., no technical information on the Spatializer, which is applied to this product, shall be provided.

AN7397K

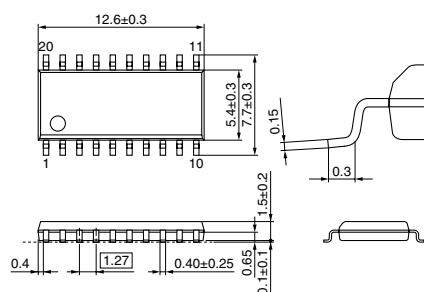
Unit: mm



SDIP020-P-0300

AN7397S

Unit: mm



SOP020-P-0300B

Note) The packages (SDIP020-P-0300 and SOP020-P-0300B) of this product will be changed to lead-free type (SDIP020-P-0300A and SOP020-P-0300E). See the new package dimensions section later of this datasheet.

■ Pin Descriptions

Pin No.	Description	Pin No.	Description
1	L-in	11	SDA
2	1/2 V _{CC}	12	R-det.1
3	L-out	13	R-det.2
4	S-out	14	V _{CC}
5	R-out	15	Space
6	R-ret.	16	VCA
7	Mode	17	F-in
8	L-ret.	18	F-out
9	D-GND	19	R-in
10	SCL	20	GND

■ Absolute Maximum Ratings

Parameter	Symbol	Rating	Unit
Supply voltage	V _{CC}	7.0	V
Supply current	I _{CC}	100	mA
Power dissipation *2	P _D	230	mW
Operating ambient temperature *1	T _{opr}	−25 to +75	°C
Storage temperature *1	T _{stg}	−55 to +125	°C

Note) *1: Except for the operating ambient temperature and storage temperature, all ratings are for T_a = 25°C.

*2: The power dissipation shown is the value for T_a = 75°C

■ Recommended Operating Range

Parameter	Symbol	Range	Unit
Supply voltage	V _{CC}	4.5 to 6.8	V

■ Electrical Characteristics at $V_{CC} = 5\text{ V}$, $f = 1\text{ kHz}$, $T_a = 25^\circ\text{C} \pm 2^\circ\text{C}$

Parameter	Symbol	Conditions	Min	Typ	Max	Unit
Total circuit current	I_{TOTAL}	$V_{IN} = 0\text{ mV}$	18	25	32	mA
Maximum output voltage ^{*3}	V_{OUT1}	L-in, R-in THD = 1%	0.8	1.0	—	V[rms]
Output noise voltage 1 ^{*1, 4}	V_{NO1}	L-out, R-out $R_G = 4.7\text{ k}\Omega$	—	20	50	$\mu\text{V[rms]}$
Voltage gain 1 ^{*3}	G_{V1}	L-out, R-out $V_{IN} = 400\text{ mV}$	-2	0	2	dB
Total harmonic distortion 1 ^{*2, 3}	THD_1	L-out, R-out $V_{IN} = 400\text{ mV}$	—	0.05	0.2	%
Output noise voltage 2 ^{*1, 5}	V_{NO2}	S-out $R_G = 4.7\text{ k}\Omega$	—	80	200	$\mu\text{V[rms]}$
Voltage gain 2 ^{*6}	G_{V2}	S-out $V_{IN} = 60\text{ mV}$	343	450	685	mV[rms]
Total harmonic distortion 2 ^{*2, 6}	THD_2	S-out $V_{IN} = 60\text{ mV}$	—	0.15	0.3	%

I²C interface

Sink current at ACK	I_{ACK}	Maximum value of sink current of pin 11 at ACK	2.0	10	—	mA
SCL/SDA signal input high- level	V_{IHI}		2.5	—	3.5	V
SCL/SDA signal input low- level	V_{ILO}		0	—	0.5	V
Input-enable maximum frequency	f_{Imax}		—	—	100	Kbit/s

Note) *1: In measuring, the filter with A-characteristic curve is used.

*2: In measuring, the filter for the range of 15 Hz to 30 kHz (12 dB/OCT) is used.

*3: Mode: ST, L-in + R-in, VCA (I²C data: BFH)

*4: Mode: ST, VCA (I²C data: BFH)

*5: Mode: ST, VCA (I²C data: 80 H)

*6: Mode: ST, VCA (I²C data: 80 H) for either L-in or R-in

• Design reference data

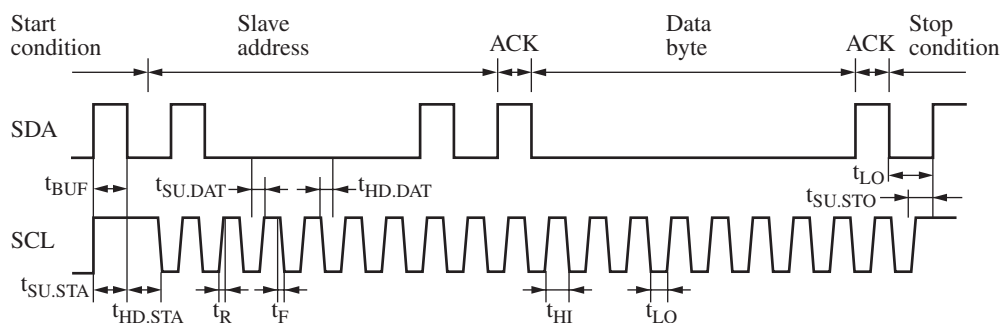
Parameter	Symbol	Conditions	Min	Typ	Max	Unit
I ² C interface						
Bus free before start	t_{BUF}		4.0	—	—	μs
Start condition set-up time	$t_{SU, STA}$		4.0	—	—	μs
Start condition hold time	$t_{HD, STA}$		4.0	—	—	μs
SCL/SDA low period	t_{LO}		4.0	—	—	μs
SCL high period	t_{HI}		4.0	—	—	μs
SCL/SDA rise time	t_R		—	—	1.0	μs
SCL/SDA fall time	t_F		—	—	0.35	μs
Data set-up time (Write)	$t_{SU, DAT}$		0.25	—	—	μs
Data hold time (Write)	$t_{HD, DAT}$		0	—	—	μs
Acknowledge set-up time	$t_{SU, ACK}$		—	—	3.5	μs
Acknowledge hold time	$t_{HD, ACK}$		0	—	—	μs
Stop condition set-up time	$t_{SU, STO}$		4.0	—	—	μs

DAC

6-bit DAC DNLE	L_6	1 LSB = (Data (max.) – Data (00))/63	0.1	1.0	1.9	$\frac{\text{LSB}}{\text{step}}$
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■ Electrical Characteristics at $V_{CC} = 5\text{ V}$, $f = 1\text{ kHz}$, $T_a = 25^\circ\text{C} \pm 2^\circ\text{C}$ (continued)

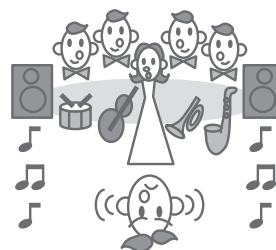
• DAC timing chart



■ Conceptual Explanation of Spatializer Operation

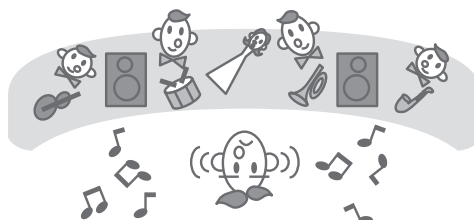
• Normal stereo

All sounds are heard from only between two speakers, right and left.



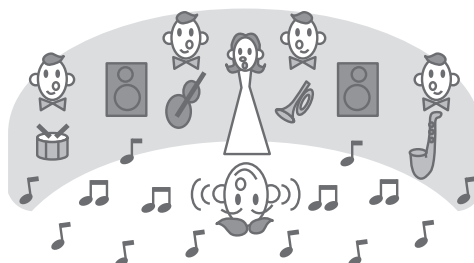
• Conventional surround

The sound expands toward the outside of the speaker system, but the sound position comes apart mostly in the conventional systems.

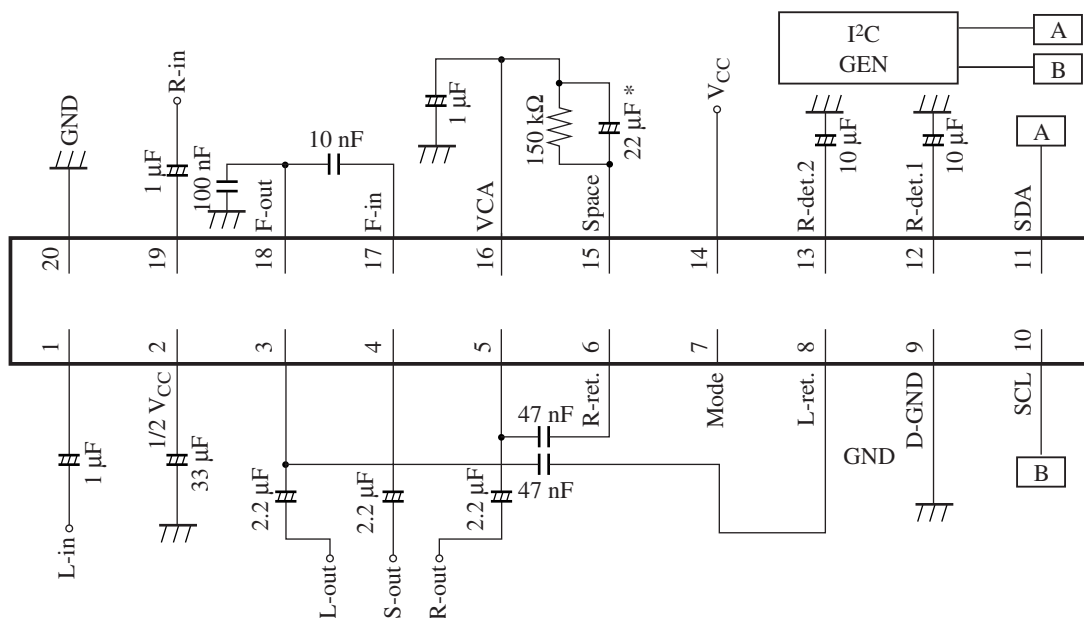


• Spatializer

The sound expands toward the outside of the two speakers, and yet their positions are stable and an expanded, deep sound are gotten.



■ Application Circuit Example (Basic circuitry)

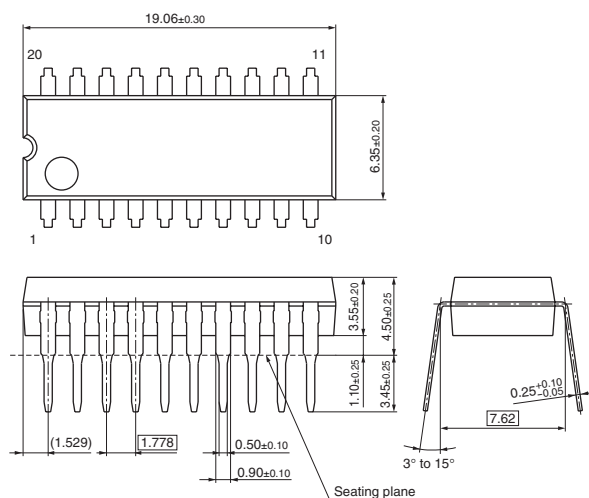


Note) When switching noise occurs at mode switching, insert a capacitor between pin 7 and GND.

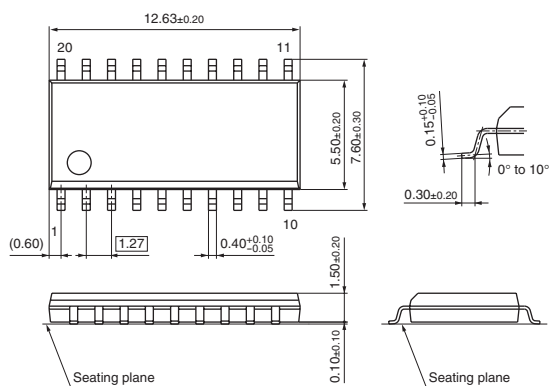
*: For the capacitor of 22 μ F, use that of a non-polar type.

■ New Package Dimensions (Unit: mm)

- SDIP020-P-0300A (Lead-free package)



- SOP020-P-0300E (Lead-free package)



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